

3A, 45V - 60V Trench Schottky Surface Mount Rectifier

FEATURES

- Excellent high temperature stability
- Low forward voltage
- Lower power loss/ high efficiency
- High forward surge capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

APPLICATIONS

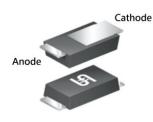
- Switching mode power supply (SMPS)
- Adapters
- DC to DC converter

MECHANICAL DATA

- Case: SOD-123HE
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.022g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
lf	3	А		
V _{RRM}	45 - 60	V		
IFSM	60	А		
T _{J MAX}	150	°C		
Package	SOD-123HE			
Configuration	Single die			





SOD-123HE



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
PARAMETER	SYMBOL	TSSE3H45	TSSE3H60	UNIT	
Marking code on the device		E3H45	E3H60		
Repetitive peak reverse voltage	V _{RRM}	45	60	V	
Reverse voltage, total rms value	V _{R(RMS)}	32	42	V	
Forward current	lF	3		Α	
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	60		А	
Junction temperature	TJ	- 55 to +150		°C	
Storage temperature	T _{STG}	- 55 to +150		°C	



THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ТҮР	UNIT	
Junction-to-lead thermal resistance	R _{ejL}	20	°C/W	

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage ⁽¹⁾	TSSE3H45	$I_F = 3A, T_J = 25^{\circ}C$	VF	0.48	0.57	V
		I _F = 3A, T _J = 125°C		0.42	0.50	V
	TSSE3H60	$I_F = 3A, T_J = 25^{\circ}C$		0.56	0.60	V
		$I_F = 3A, T_J = 125^{\circ}C$		0.50	0.53	V
Reverse current @ rated $V_R^{(2)}$		T _J = 25°C	I _R	-	100	μA
		T _J = 125°C		-	25	mA

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING		
TSSE3Hx	SOD-123HE	10,000 / Tape & Reel		

Notes:

1. "x" defines voltage from 45V(TSSE3H45) to 60V(TSSE3H60)



Taiwan Semiconductor

CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

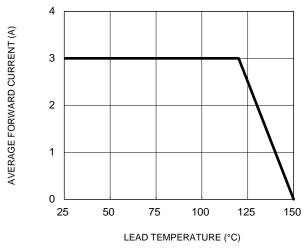
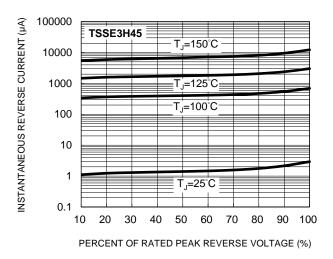
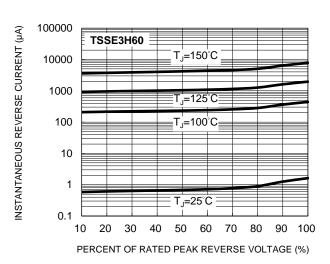


Fig.1 Forward Current Derating Curve



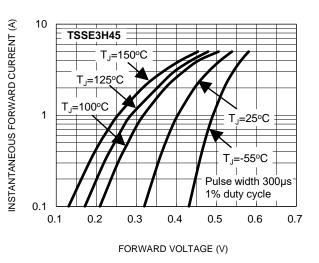






1000 TSSE3H45 CAPACITANCE (pF) 100 TSSE3H60 f=1.0MHz Vsig=50mVp-p 10 0.1 1 10 100 **REVERSE VOLTAGE (V)**

Fig.4 Typical Forward Characteristics





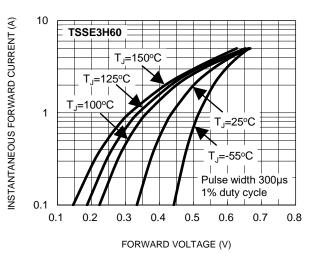
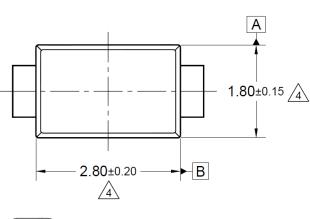


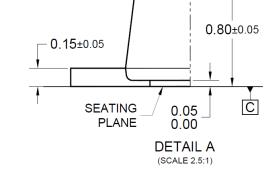
Fig.2 Typical Junction Capacitance



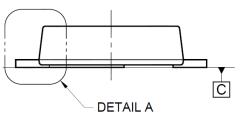
Taiwan Semiconductor

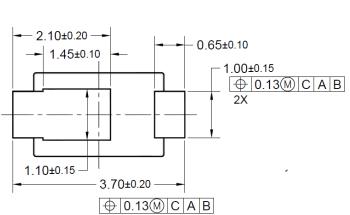
PACKAGE OUTLINE DIMENSIONS

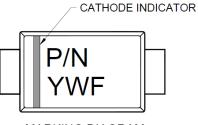




SOD-123HE



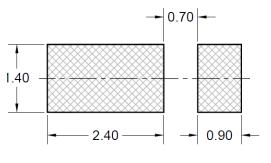




MARKING DIAGRAM

P/N = MARKING CODE

- YW = DATE CODE
- F = FACTORY CODE



SUGGESTED PAD LAYOUT

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.
- 3. THERE IS NO EXISTING INDUSTRY STANDARD FOR THIS PACKAGE.
- MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
- 5. DWG NO. REF: HQ2SD07-SOD123HE-038 REV A.



<u>TSSE3H45 – TSSE3H60</u>

Taiwan Semiconductor

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.